

WHAT IS CLAIMED IS:

1. A card body comprising:

a card part onto which an IC module is to be mounted,
5 the IC module including an IC chip and a contact pattern;
and

a bracket part to support the card part;

wherein

the card part includes a bevel, and

10 the bracket part includes

a hole formed at a circumference of the card part,

a first bridge part connecting the bracket part and
the card part,

a second bridge part connecting the bracket part and
15 the card part, the second bridge part is provided at a
farer position from the bevel than the first bridge part,

a first break-off line provided ~~with a first depth~~ at
both surfaces of a connection part between the card part
and the first bridge part so that a thickness of the
20 connection part is equal to a first thickness, and

a second break-off line provided ~~with a second depth~~
at both surfaces of a connection part between the card part
and the second bridge part so that a thickness of the
connection part is equal to a second thickness, the first
25 thickness being shorter than the second thickness ~~the second~~
~~depth being shallower than the first depth.~~

2. The card body according to claim 1, wherein
the card part has a rectangular shape,

the first bridge part is provided at a short side of the card part nearer to the bevel, and

the second bridge part is provided at another short side of the card part as the opposite side of the first
5 bridge part.

3. The card body according to claim 1, wherein the card part has a rectangular shape, the first bridge part is provided at a long side of
10 the card part nearer to the bevel, and

the second bridge part is provided at another long side of the card part as the opposite side of the first bridge part.

15 4. The card body according to claim 1, wherein a width of the first bridge part is narrower than a width of the second bridge part.

5. The card body according to claim 2, wherein
20 a width of the first bridge part is narrower than a width of the second bridge part.

6. The card body according to claim 3, wherein a width of the first bridge part is narrower than a
25 width of the second bridge part.

7. A card body comprising:
a card part onto which an IC module is to be mounted, the IC module including an IC chip and a contact pattern;
30 and

a bracket part to support the card part;
wherein
the card part includes a bevel, and
the bracket part includes
5 a hole formed at a circumference of the card part,
a first bridge part connecting the bracket part and
the card part,
a second bridge part connecting the bracket part and
the card part, a width of the second bridge part is wider
10 than a width of the first bridge part,
a first break-off line provided at both surfaces of a
connection part between the card part and the first bridge
part so that a thickness of the connection part is equal to
a first thickness, and
15 a second break-off line provided at both surfaces of a
connection part between the card part and the second bridge
part so that a thickness of the connection part is equal to
a second thickness, the first thickness being shorter than
the second thickness.

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8. The card body according to claim 7, wherein
the card part has a rectangular shape,
the first bridge part is provided at a short side of
the card part nearer to the bevel, and
25 the second bridge part is provided at another short
side of the card part as the opposite side of the first
bridge part.

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9. The card body according to claim 7, wherein
the card part has a rectangular shape,

the first bridge part is provided at a long side of the card part nearer to the bevel, and

the second bridge part is provided at another long side of the card part as the opposite side of the first
5 bridge part.

10. A manufacturing method for an IC card from a card body,

the card body including a card part onto which an IC
10 module is to be mounted, and a bracket part to support the card part,

the IC module including an IC chip and a contact pattern,

the method comprising:

15 forming a bevel at the card part;

forming a hole at a circumference of the card part on the bracket part;

forming a first bridge part connecting the bracket part and the card part;

20 forming a second bridge part connecting the bracket part and the card part at a farer position from the bevel than the first bridge part;

forming a first break-off line ~~with a first depth at~~ both surfaces of a connection part between the card part
25 and the first bridge part so that a thickness of the connection part is equal to a first thickness; and

forming a second break-off line ~~with a second depth at~~ both surfaces of a connection part between the card part
30 and the second bridge part so that a thickness of the connection part is equal to a second thickness, the first

~~thickness being shorter than the second thickness~~
~~depth being shallower than the first depth.~~

11. An IC card manufactured from a card body,
5 the card body comprising:
a card part onto which an IC module is to be mounted,
the IC module including an IC chip and a contact pattern;
and
a bracket part to support the card part;
10 wherein
the card part includes a bevel,
the bracket part includes
a hole formed at a circumference of the card part,
a first bridge part connecting the bracket part and
15 the card part,
a second bridge part connecting the bracket part and
the card part, the second bridge part is provided at a
farer position from the bevel than the first bridge part,
a first break-off line provided ~~with a first depth~~ at
20 both surfaces of a connection part between the card part
and the first bridge part so that a thickness of the
connection part is equal to a first thickness, and
a second break-off line provided ~~with a second depth~~
at both surfaces of a connection part between the card part
25 and the second bridge part so that a thickness of the
connection part is equal to a second thickness, the first
thickness being shorter than the second thickness
~~depth being shallower than the first depth,~~

the IC card is the card part separated from the bracket part by cutting the first break-off line and the second break-off line by pressure.